

MXG X-Series Signal Generator N5181B Analog & N5182B Vector

9 kHz to 3 or 6 GHz 9 kHz to 7.21 GHz



1. Only applicable to N5182B + N5182BX07 Frequency Extender



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Definitions and Conditions

Specifications represent warranted performance of a calibrated instrument that has been stored for a minimum of 2 hours within the operating temperature of 0 to 55 °C, unless otherwise stated, and after a 45 minute warm-up period. The specifications include measurement uncertainty. Data represented in this document are specifications unless otherwise noted.

Typical (typ) describes additional product performance information that is not covered by the product warranty. It is performance beyond specifications that 80 percent of the units exhibit with a 90 percent confidence level at room temperature (approximately 25 °C). Typical performance does not include measurement uncertainty.

Nominal (nom) values indicate the expected mean or average performance, or an attribute whose performance is by design, such as the 50 ohm connector. This data is not warranted and is measured at room temperature (approximately 25 °C).

Measured (meas) describes an attribute measured during the design phase for purposes of communicating expected performance, such as amplitude drift vs. time. This data is not warranted and is measured at room temperature (approximately 25 °C).



Pure and Precise

On the path to better performance, the Keysight Technologies, Inc. MXG X-Series signal generators are fine-tuned to be your "golden transmitter" in R&D. Whether you're pushing for a linear RF chain or an optimized link budget, the analog and vector MXG models deliver what you need: phase noise, ACPR, channel coding, and more. Take your devices and designs to the limit with the MXG.

Frequency Specifications

Frequency range				
Frequency range	Option 503	9 kHz to 3 GHz		
	Option 506	9 kHz to 6 GHz		
	Option 506 + FRQ	9 kHz to 7.2 GHz ¹		
Resolution	0.001 Hz			
Phase offset	Adjustable in nominal 0.1° increments			
	Frequency bands ²			
Band	Frequency range	N		
1	9 kHz to < 5 MHz	1 (digital synthesis)		
1	5 to < 250 MHz	1		
2	250 to < 375 MHz	0.25		
3	375 to < 750 MHz	0.5		
4	750 to < 1500 MHz	1		
5	1500 to < 3000.001 MHz	2		
5	3000.001 to 6000 MHz 4			

Only applicable to N5182B; requires option 506 and N5182BX07 Frequency Extender. N is a factor used to help define certain specifications within the document.

Frequency switching speed ^{1, 2}					
	Standard	Option UNZ ³	Option UNZ, typical		
CW mode					
SCPI mode	≤ 5 ms, typical	≤ 1.15 ms	≤ 950 µs		
List/step sweep mode	≤ 5 ms, typical	≤ 900 µs	≤ 800 µs		
Digital modulation on (N5182B only)					
SCPI mode	≤ 5 ms, typical	≤ 1.15 ms	≤ 1.05 ms		
List/step sweep mode	≤ 5 ms, typical	≤ 900 µs	≤ 800 µs		

^{1.} Time from receipt of SCPI command or trigger signal to within 0.1 ppm of final frequency or within 100 Hz, whichever

Frequency reference			
Accuracy	± (time since last adjustment x aging rate) ± temperature effects ± line voltage effects ± calibration accuracy		
Internal time base reference oscillator aging rate ¹	< ± 1 x 10-7/year < ± 5 x 10-10/day after 30 days		
Initial achievable calibration accuracy	± 4 x 10-8 or ± 40 ppb		
Adjustment resolution	< 1 x 10-10		
Temperature effects	< ± 2 x 10-10, nominal		
Line voltage effects	< ± 1 x 10-9 for ± 10% change, nominal		

is greater.

2. With internal channel corrections on, the frequency switching speed is <1.3 ms measured for list mode and SCPI mode cached frequency points. For the initial frequency point in SCPI mode the time is <3.3 ms measured. The instrument will automatically cache the most recently used 1024 frequencies. There is no speed degradation for amplitude-only changes.

^{3.} Specifications apply when statues register updates are off. For export control purposes CW switching speed to within 0.05% of final frequency is 190 µs (measured).

Reference output	
Frequency	10 MHz
Amplitude	≥ +4 dBm, nominal into 50 Ω load
External reference input	
Input frequency, standard	10 MHz
Input frequency, Option 1ER	1 to 50 MHz (in multiples of 0.1 Hz) ²
Stability	Follows the stability of external reference input signal
Lock range	± 1 ppm
Amplitude	-3 dBm to +20 dBm, nominal
Impedance	50 Ω , nominal
Waveform	Sine or square
Sweep modes (frequency and amplitude)	
Operating modes	Step sweep (equally spaced frequency and amplitude or logarithmically spaced frequency steps) List sweep (arbitrary list of frequency and amplitude steps) Simultaneously sweep waveforms with N5182B; see Baseband Generator section for more detail
Sweep range	Within instrument frequency range
Dwell time	100 μs to 100 s
Number of points	2 to 65535 (step sweep) 1 to 3201 (list sweep)
Step change	Linear or logarithmic
Triggering	Free run, trigger key, external, timer, bus (GPIB, LAN, USB)

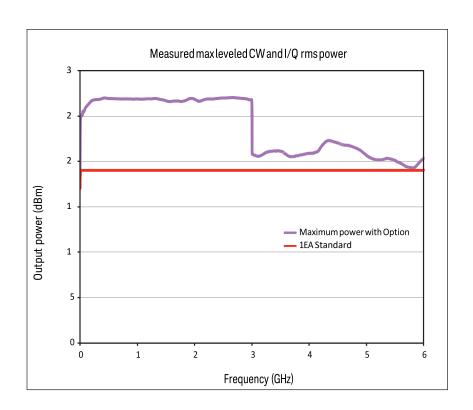
Not verified by Keysight N7800A TME Calibration and Adjustments Software. Daily aging rate may be verified as a supplementary chargeable service, on request.

Close-in phase noise will degrade when reference input is tuned away from 10 MHz.

Amplitude Specifications

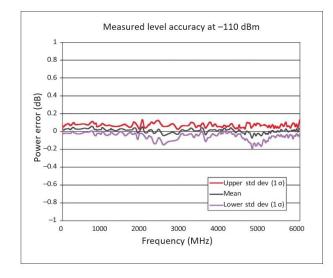
Output parameters			
Settable range	+19 to -144 dBm (Standard) +30 to -144 dBm (Option 1EA)		
Resolution	0.01 dB		
Step attenuator	0 to 130 dB in 5 dB steps electronic type		
Connector	Type N 50 Ω, nominal		
	Max output power ¹ () = typical		
Frequency	Standard	Option 1EA	
9 kHz to 10 MHz	+13 dBm	+17 dBm (+18 dBm)	
10 MHz to 3 GHz	+18 dBm	+24 dBm (+26 dBm)	
3 to 5 GHz	+16 dBm	+19 dBm (+20 dBm)	
5 to 6.0 GHz	+16 dBm	+18 dBm (+19 dBm)	

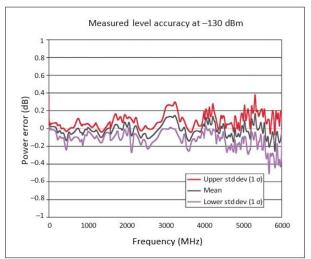
^{1.} Quoted specifications between 20 °C and 30 °C. Maximum output power typically decreases by 0.01 dB/°C for temperatures outside this range.

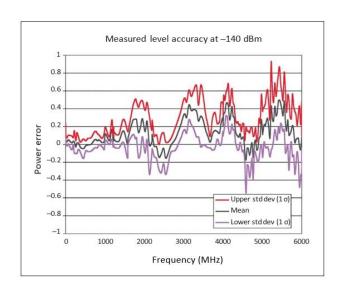


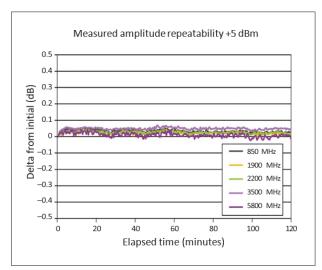
Absolute level accuracy in CW mode ¹ (ALC on) ()= typical				
		Standard		Option 1EQ
Range	Max powe	er to -60 dBm	< –60 to –110 dBm	< –110 to –127 dBm
9 to 100 kHz	(± 0.6 dB)		(± 0.9 dB)	
100 kHz to 5 MHz	± 0.8 dB (:	± 0.3)	± 0.9 dB (± 0.3)	
5 MHz to 3 GHz	± 0.6 dB (:	± 0.3)	± 0.8 dB (± 0.3)	± 1.5 dB (± 0.5)
3 to 6 GHz	± 0.6 dB (± 0.3)		± 1.1 dB (± 0.3)	± 1.6 dB (± 0.6)
Absolute level accuracy in CW mode (ALC off, power search run, relative to ALC on)				
9 kHz to 6 GHz		± 0.15 dB, typical		
Absolute level accuracy in digital I/Q mode (N5182B only)				
(ALC on, relative to CW, W-CDMA	1 DPCH configuration < +10 dBm)			
5 MHz to 6 GHz		± 0.25 dB, (0.05 dB)		

1. Quoted specifications between 20 °C and 30 °C. For temperatures outside this range, absolute level accuracy degrades by 0.01 dB/°C. Output power may drift up to 0.10 dB < 3 GHz and 0.15 dB > 3 GHz per g/kg change in absolute humidity (nom).





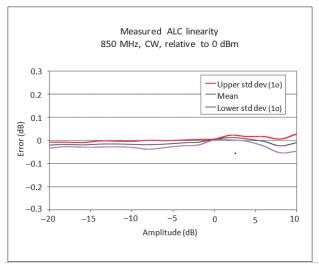


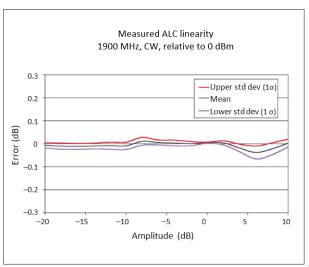


Measured relative level accuracy at 850 MHz initial power +10 dBm 0.5 0.4 Upperstddev(1σ 0.3 Lowerstddev(1 a 0.2 Power error (dB) 0.1 -0.1 -0.2-0.3 -0.4 -0.5 -40 -80 0 -20-60 -100-120-140Final power (dBm)

Repeatability measures the ability of the instrument to return a given power setting after a random excursion to any other frequency and power setting. It should not be confused with absolute level accuracy.

Relative level accuracy measures the accuracy of a step change from any power level to any other power level. This is useful for large changes (such as 5 dB steps).

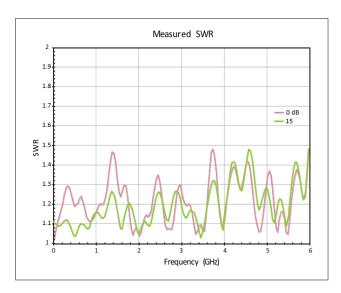


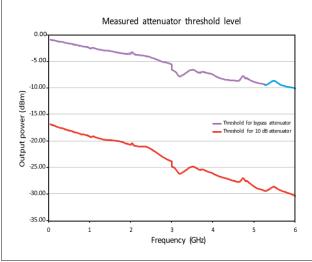


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SWR (measured CW mode) ¹			
Frequency	Attenuator state		
	Bypass	0 to 10 dB	15 dB or more
≤ 1.0 GHz	< 1.3:1	< 1.35:1	< 1.2:1
1.0 to 2 GHz	< 1.55:1	< 1:5:1	< 1.3:1
2 to 3 GHz	< 1.8:1	< 1.5:1	< 1.45:1
3 to 4 GHz	< 1.5:1	< 1.6:1	< 1.7:1
4 to 6 GHz	< 1.9:1	< 1.6:1	< 1.6:1

^{1.} SWR < 1.60:1 below 30 kHz.





		Maximum revers	e power, nominal	
< 1 GHz		50 W		
1 to 2 GHz		25 W		
2 to 6 GHz		20 W		
Max DC voltage		50 VDC		
Trip level		2 W		
Amplitude switching speed ¹		Standard Option UNZ Option UNZ, typical		Option UNZ, typical
CW mode				
SCPI mode	≤ 5 ms, typ	pical	≤ 750 µs	≤ 650 µs
Power search SCPI mode	< 12 ms, n	neasured		
List/step sweep mode	≤ 5 ms, typ	pical	≤ 500 µs	≤ 300 µs
Digital modulation on (N5182B c	only)			
SCPI mode	≤ 5 ms, typ	pical	≤ 1.15 ms	≤ 950 µs
Power search SCPI mode	< 12 ms, n	neasured		
List/step sweep mode	≤ 5 ms, typ	pical	≤ 900 µs	≤ 400 µs
		Alternate power level	control (N5182B only)	
Switching time (via waveform markers)		20 µs within ± 1 dB, m	neasured	
Functional power range		-15 dBm to -144 dBm	, measured	
		User flatnes	s correction	
Number of points		3201		
Number of tables		Dependent on availabl	e free memory in instrument; 10,000) maximum
Entry modes		USB/LAN direct power manual USB/GPIB pov	meter control, LAN to GPIB and US	BB to GPIB, remote bus and
Sweep modes				
See Frequency Specifications section for more detail				

Time from receipt of SCPI command or trigger signal to amplitude settled within 0.2 dB. Switching speed specifications apply when status register updates are off.

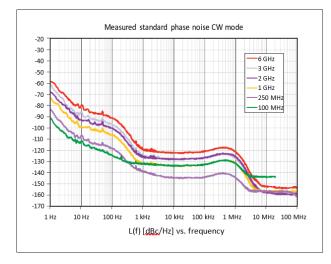
Spectral Purity Specifications

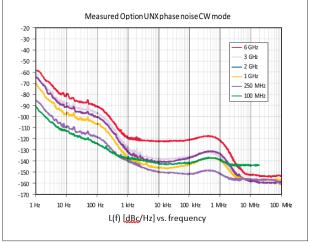
Standard absolu	te SSB phase noise (dBc/Hz, CW, at 20 kHz offset) () = typical ¹
5 MHz to < 250 MHz	-129 (-133)
250 MHz	-140 (-143)
500 MHz	–135 (–139)
1 GHz	-131 (-134)
2 GHz	-124 (-127)
3 GHz	–123 (–127)
4 GHz	–118 (–122)
6 GHz	-116 (-121)
Option UNX absol	ute SSB phase noise (dBc/Hz, CW, at 20 kHz offset) () = typical ¹
Option UNX absol	ute SSB phase noise (dBc/Hz, CW, at 20 kHz offset) () = typical ¹ -140 (-143)
5 MHz to < 250 MHz	-140 (-143)
5 MHz to < 250 MHz 250 MHz	-140 (-143) -144 (-150)
5 MHz to < 250 MHz 250 MHz 500 MHz	-140 (-143) -144 (-150) -143 (-150)
5 MHz to < 250 MHz 250 MHz 500 MHz 1 GHz	-140 (-143) -144 (-150) -143 (-150) -141 (-146)
5 MHz to < 250 MHz 250 MHz 500 MHz 1 GHz 2 GHz	-140 (-143) -144 (-150) -143 (-150) -141 (-146) -135 (-141)

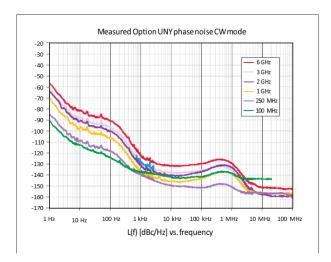
^{1.} From 20 to 30 °C, excludes mechanic vibration, measured @ +10 dBm or maximum specified power, whichever is less.

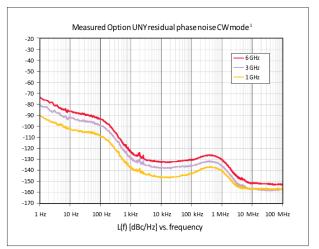
	(Option UNY absolute	e SSB phase noise	(CW) () = measured	 1	
Frequency	1 Hz	10 Hz	100 Hz	1 kHz	10 kHz	100 kHz
100 MHz	(-91)	(–113)	(–124)	(–137)	(-142)	(-142)
249 MHz	(-85)	-93 (-110)	-103 (-118)	-130 (-137)	-139 (-142)	-138 (-142)
250 MHz	(-85)	-96 (-110)	-104 (-118)	-127 (-139)	-144 (-150)	-147 (-152)
500 MHz	(-74)	-89 (-100)	-98 (-109)	-125 (-139)	-139 (-149)	-145 (-149)
1 GHz	(-70)	-87 (-97)	-93 (-106)	-123 (-136)	-141 (-146)	-140 (-143)
2 GHz	(-65)	-79 (- 90)	-85 (-101)	-114 (-131)	-135 (-140)	-134 (-137)
3 GHz	(-61)	-74 (-88)	-81 (-98)	-112 (-128)	-132 (-138)	-131 (-135)
4 GHz	(-61)	-73 (-84)	-79 (-95)	-110 (-124)	-130 (-134)	-127 (-131)
6 GHz	(–57)	-69 (-81)	-76 (- 91)	-107 (-121)	-126 (-132)	-125 (-129)

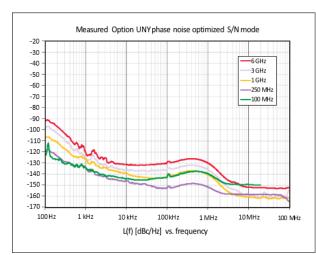
^{1.} From 20 to 30 °C, excludes mechanic vibration, measured @ +10 dBm or maximum specified power, whichever is less.

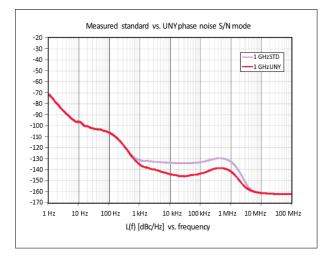


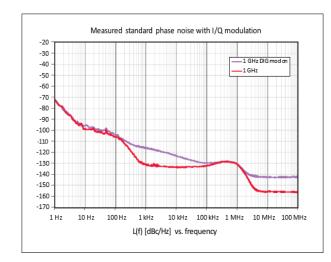


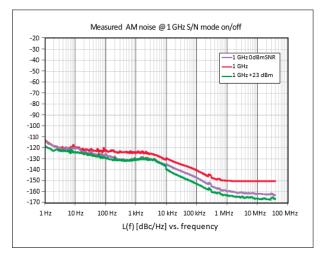












1. Use external 10 MHz input path, between +3 to +7 dBm for maximum performance.

Residual FM (CW mode, 300 Hz to 3 kHz BW, CCITT, rms)				
5 MHz to 6 GHz	< N x 2 Hz (measured) (see N value in frequen	cy band table)		
Resid	dual AM (CW mode, 0.3 to 3 kHz BW, rms, +5	dBm)		
100 kHz to 3 GHz	< 0.01% (measured)			
Harmonics (CW mode)				
Range	Standard < +4 dBm	Option 1EA < +12 dBm		
9 kHz to 3 GHz	<-35 dBc	< –30 dBc		
3 to 4 GHz	< –35 dBc, typical	< –35 dBc, typical		
4 to 6 GHz	< –53 dBc, typical	< –40 dBc, typical		
	Nonharmonics (CW mode) ¹() = typical			
Range	10 KHz offset			
	Standard (dBc)	UNX or UNY (dBc)		
9 kHz to < 5 MHz	–65, nominal	–65, nominal		
5 to < 250 MHz	-75	-75 (- 80)		
250 to < 750 MHz	-87			
	-67	-96 (-100)		
750 MHz to < 1.5 GHz	_87	-96 (-100) -92 (-96)		
750 MHz to < 1.5 GHz 1.5 to < 3.0 GHz				
	-87	-92 (-96)		
1.5 to < 3.0 GHz	_87 _81	-92 (-96) -86 (-90)		
1.5 to < 3.0 GHz	-87 -81 -75	-92 (-96) -86 (-90)		
1.5 to < 3.0 GHz 3 to 6 GHz	-87 -81 -75 Subharmonics (CW mode) () = typical	-92 (-96) -86 (-90)		

^{1. &}lt; 3 GHz fixed 100 MHz spur is specified @ -78 dBc. In signal-to-noise optimization mode 100 MHz spur is < -100 dBc, measured.

Jitter (standard phase noise) 1					
Carrier frequency	SONET/SDH data r	ate	rms jitter BW	μUI rms, typical	Seconds, typical
155 MHz	155 MB/s		100 Hz to 1.5 MHz	91.8	0.6 ps
622 MHz	622 MB/s		1 KHz to 5 MHz	50.5	81 fs
2.488 GHz	2488 MB/s		5 kHz to 20 MHz	198	80 fs
Jitter (UNX or UNY phase noise) ¹					
Carrier frequency	SONET/SDH data rate		rms jitter BW	μUI rms, measured	Seconds, measured
155 MHz	155 MB/s		100 Hz to 1.5 MHz	40	0.25 ps
622 MHz	622 MB/s		1 KHz to 5 MHz	21	33 fs
2.488 GHz	2488 MB/s		5 kHz to 20 MHz	72	29 fs
Phase coherence (Option 012)					
LO input frequency range 250 MHz		Hz to 6 GHz, nominal			
LO input power range 0 to +12 c			2 dBm, nominal		
LO output frequency range 250 MHz to 6 GHz, nominal					

Calculated from phase noise performance in CW mode at +10 dBm. For other frequencies, data rates, or bandwidths, please consult your sales representative.

0 to +12 dBm, nominal

LO output power range

Analog Modulation Specifications

Frequency bands			
Band #	Frequency range	N	
1	9 kHz to < 5 MHz	(digital synthesis)	
1	5 to < 250 MHz	1	
2	250 to < 375 MHz	0.25	
3	375 to < 750 MHz	0.5	
4	750 to < 1500 MHz	1	
5	1500 to < 3000.001 MHz	2	
6	3000.001 to 6000 MHz 4		
Frequ	ency modulation (Option UNT) (See N value a	above)	
Max deviation	N × 4 MHz, nominal ³		
Resolution	1 Hz, nominal		
Deviation accuracy	< ± 2% + 20 Hz (1 kHz rate, deviation is N x 50 kHz)		
Modulation frequency response @ 100 kHz deviation	1 dB bandwidth 3 dB bandwidth DC/5 Hz to 3 MHz, nominal DC/1 Hz to 7 MHz, nominal		
Carrier frequency accuracy	$< \pm 0.2\%$ of set deviation + (N × 1 Hz) ¹		
Relative to CW	< ± 0.06% of set deviation + (N × 1 Hz), typical ²		
Total harmonic distortion	< 0.4% [1 kHz rate, deviation is N x 50 kHz]		
	Sensitivity	+1 V peak for indicated deviation, nominal	
FM using external inputs 1 or 2	Input impedance	50 Ω/600 Ω/1 MΩ, nominal	
	Paths	FM path 1 and FM path 2 are summed internally for composite modulation	

Specification valid for temperature changes of less than ± 5 °C since last DCFM calibration. Typical performance immediately after a DCFM calibration. Digital synthesis band FM deviation is 5 MHz.

Pł	ase modulation (Option UNT) (See N value ab	ove)		
	Normal bandwidth	N × 2 radians, nomina	al	
Maximum deviation	High-bandwidth mode	N × 0.2 radians, nomi	nal	
-	Normal bandwidth (3 dB)	DC to 1 MHz, nominal		
Frequency response	High-bandwidth mode (3 dB)	idth mode (3 dB) DC to 4 MHz, nominal		
Resolution	0.1% of deviation			
Deviation accuracy	< + 0.5% + 0.01 rad, typical [1 kHz rate, normal	< + 0.5% + 0.01 rad, typical [1 kHz rate, normal bandwidth mode]		
Total harmonic distortion	< 0.2%, typical [1 kHz rate, N x 1 radian devia	tion normal bandwidth r	node]	
	Sensitivity	+1 V peak for indicate	ed deviation, nominal	
ΦM using external inputs 1 or 2	Input impedance	50 Ω or 600 Ω or 1 M Ω , nominal		
	Paths	ΦM path 1 and ΦM path 2 are summed internally for composite modulation		
Amplitude modulation (Option UNT) ¹				
AM depth type	Linear or exponential			
Maximum depth	100%			
Depth resolution	0.1% of depth (nom)			
	f < 5 MHz	< 1.5% of setting + 1% (typ 0.5% of setting + 1%)		
AM depth error @1 kHz rate and < 80% depth	5 MHz < f < 2 GHz	< 3% of setting + 1 %		
	2 < f < 3 GHz	< 5% of setting + 1% (typical 3% of setting + 1%)		
	E & E MUL	30% depth	< 0.25%, typical	
Total harmonia diatortica @ 4 // lat-	F < 5 MHz	80% depth	< 0.5%, typical	
Total harmonic distortion @ 1 KHz rate	5 MHz < f < 2 GHz	30% depth	< 2%	
	(2 to 3 GHz is typical)	80% depth	< 2%	
Frequency response	30% depth, 3 dB BW	DC/10 Hz to 50 KHz		
Frequency response wideband AM (N5182B only)	Rates ALC off/on:	DC/800 Hz to 80 MHz	z, nominal	

^{1.} AM specifications apply 6 dB below maximum specified power from 20 to 30 °C.

			Sensitivity		\pm 1 V peak for indicated depth (Over-range can be 200% or 2.2 V peak)			
AM inputs using external inputs 1 or 2			Innut impedance				50 Ω or 600 Ω or 1M $\Omega,$ Damage level: ± 5 V max	
						AM path 1 and AM path 2 are summed internally for composite modulation		
Widehand AM inn	uts (N5182B only)		Sensitivity			1 V peak-to-peak sine wave signal with 0.5 V DC offset required input for 100% AM		
Wideballd Alvi Ilip	uts (NS 102B Offly)		Input impedance			50 Ω,	nominal (I input)	
			Simultaneo	us and composite ։	modulation ²			
Simultaneous modulation		enabled exc cannot be si baseband I/0	All modulation types (I/O, FM, AM, Φ M, and pulse modulation) may be simultaneously enabled except: FM and phase modulation cannot be combined and two modulation types cannot be simultaneously generated using the same modulation source; for example, the baseband I/Q generator, AM, and FM can run concurrently and all will modulate the output RF (this is useful for simulating signal impairments)					
Composite modula	ation		AM, FM, and ΦM each consist of two modulation paths which are summed internally for composite modulation; modulation can be any combination of internal or external sources					
	AM	FM		Phase	Pulse		Internal I/Q ¹	External I/Q 1
AM	+	+		+	+		+	+
FM	+	+		_	+		+	+
Phase	+	-		+	+		+	+
Pulse	+	+		+	_		+	+
Internal I/Q (1)	+	+		+	+		_	+
External I/Q (1)	+	+		+	+		+	_
+ = compatible, - = incompatible, * = Internal + External								

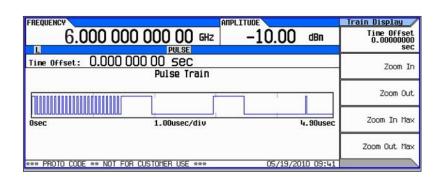
AM specifications apply 6 dB below maximum specified power from 20 to 30 $^{\circ}\text{C}.$ I/Q modulation available on N5182B.

	External modulation inputs			
(Option UNT required for FM, AM, and phase modulation inputs; Option UNW required for pulse modulation inputs)				
EXT1	AM, FM, PM			
EXT2	AM, FM, PM			
PULSE	Pulse (50 Ω only)			
I	Wideband AM (50 Ω only, N5182B only requires Q to be biased with 1.0 V)			
Input impedance	50 Ω , 1 M Ω , 600 Ω , DC and AC coupled			
	Standard internal analog modulation source			
(Single sine wave generator for use with All	M, FM, phase modulation requires Option UNT or 303)			
Waveform	Sine, square, triangle, positive ramp, negative ramp			
Rate range	0.1 Hz to 2 MHz (tunable to 3 MHz)			
Resolution	0.1 Hz			
Frequency accuracy	Same as RF reference source, nominal			
LF audio output	0 to 5 V peak into 50 Ω , –5V to 5 V offset, nominal			
Multifunction generator (Option 303)				
	303) consists of seven waveform generators that can be set independently with up to odulation features in AM, FM/PM, and LF out			
Waveform				
Function generator 1	Sine, triangle, square, positive ramp, negative ramp, pulse			
Function generator 2	Sine, triangle, square, positive ramp, negative ramp, pulse			
Dual function generator	Sine, triangle, square, positive ramp, negative ramp, phase offset, and amplitude ratio for Tone 2 relative to Tone 1			
Swept function generator	Sine, triangle, square, positive ramp, negative ramp Trigger: free run, trigger key, bus, external, internal, timer trigger			
Noise generator 1	Uniform, Gaussian			
Noise generator 2	Uniform, Gaussian			
DC	Only for LF output –5 V to +5 V, nominal			

Frequency parameters			
Sine wave	0.1 Hz to 10 MHz		
Triangle, square, ramp, pulse	0.1 Hz to 1 MHz, nominal		
Noise bandwidth	10 MHz, nominal		
Resolution	0.1 Hz		
Frequency accuracy	Same as RF reference source, nominal		
Nar	row pulse modulation (Option UNW) ¹() = typical		
On/off ratio	(> 80 dB)		
Rise/fall times (T _r , T _f)	< 10 ns; (7 ns)		
Minimum pulse width ALC on/off	> 2 µs/> 20 ns		
Repetition frequency ALC on/off	10 Hz to 500 kHz/DC to 10 MHz		
Level accuracy (relative to CW) ALC on/off ²	< ± 1.0 (± 0.5) dB/(< ± 0.5) dB		
Width compression (RF width relative to video out)	(< 5 ns)		
Video feed-through ³ ≤ 3GHz/> 3 GHz	(< 50 mV/< 5mV)		
External video delay (ext input to video)	30 ns, nominal		
RF delay (video to RF output)	20 ns, nominal		
Pulse overshoot	(< 15%)		
Input level	+1 Vpeak = RF on into 50 Ω , nominal		
T _d video delay (variable) T _w video pulse width (variable) T _p pulse period (variable) T _m RF delay T _{rf} RF pulse width T _f RF pulse fall time T _r RF pulse rise time V _{or} pulse overshoot V _f Video feedthrough	Sync Output Video 50% Output T RF Pulse Output 10% T T T T T T T T T T T T T		

- Pulse specifications apply to frequencies > 100 MHz and power set to > -3 dBm. Operable down to 9 kHz. With power search on.
 Video feed through applies to power levels < +10 dBm.

Internal pulse generator (included with Option UNW)				
Modes	Free-run, square, triggered, adjustable doublet, trigger doublet, gated, and external pulse			
Square wave rate	0.1 Hz to 10 MHz, 0.1 Hz resolution, nominal			
Pulse period	30 ns to 42 seconds, nominal			
Pulse width	20 ns to pulse period –10 ns, nominal			
Resolution	10 ns			
Adjustable trigger delay	(- pulse period + 10 ns) to (pulse width -10 ns)			
	Free run	–3.99 to 3.97 μs		
Settable delay	Triggered	0 to 40 s		
Resolution (delay, width, period)	10 ns, nominal			
	1st pulse delay	(Relative to sync out) 0 to 42 s – pulse width – 10 ns		
Pulse doublets	1st pulse width	500 ns to 42 s – delay – 10 ns		
Talde deducted	2nd pulse delay	0 to 42 s - (Delay 1 + Width 2) - 10 ns		
	2nd pulse width	20 ns to 42 s – (Delay 1 + Delay 2) – 10 ns		
Pulse train generator Option N5180320B (requires Option UNW)				
Number of pulse patterns	2047			
On/off time range	20 ns to 42 sec			



Avionics (Option N5180302B)			
VOR			
Bearing accuracy		± 0.1°	
Frequency accuracy		Same as RF reference source, nominal	
AM accuracy	30% depth	± 5% of setting	
AM distortion		2%	
FM accuracy	480 Hz deviation	± 1.7 Hz	
ILS: localizer and glide slope			
AM accuracy	AM accuracy 40% depth		
AM distortion		2%	
Difference in depth of modulation (DDM)	Localizer	0.0002	
resolution	Glide slope	0.0004	
Difference in depth of modulation (DDM)	Localizer	± 0.0004 ± 5% of DDM ¹	
accuracy	Glide slope	± 0.0008 ± 5% of DDM ¹	
Marker beacon			
Marker tone AM accuracy	95% depth	± 5% of setting + 1%	
Marker tone AM distortion	95% depth	5%	

^{1.} DDM must not be equal to 0.

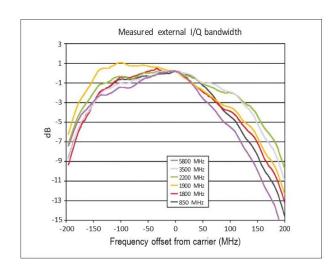
Vector Modulation Specifications

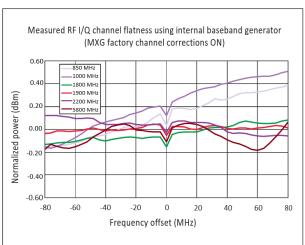
N5182B Only

I/Q modulator external inputs				
Bandwidth	Baseband (I or Q)	Up to 100 MHz baseband, nominal		
Barrowicti	RF (I+Q)	Up to 200 MHz RF		
I or Q offset	± 100 mV (200 uV resolution)	± 100 mV (200 uV resolution)		
I/Q gain balance	± 4 dB (0.001 dB resolution)	± 4 dB (0.001 dB resolution)		
I/Q attenuation	0 to 50 dB (0.01 dB resolution)			
Quadrature angle adjustment	± 200 units (0.1 units resolution)			
Full scale input drive (I+Q)	0.5 V into 50 Ω, nominal			
Internal I/Q baseband generator adjustments ^{1,2} (Options 656 and 657)				
I/Q offset	± 20% (0.025% resolution)			
I/Q gain	± 1 dB (0.001 dB resolution)			
Quadrature angle adjustment	± 10 ° (0.01 degrees resolution)			
I/Q phase	± 360.00 ° (0.01 degrees resolution)			
I/Q skew	± 800.00 ns (1 picosecond resolution)			
I/Q delay	± 250.00 ns (1 picosecond resolution)			
	External I/Q outputs ¹			
Impedance	50 Ω, nominal per output			
impedance	100 Ω , nominal differential output			
Туре	Single-ended or differential (Option 1EL)			
Maximum voltage per output	1 V peak-to-peak or 0.5 V peak			
Pandwidth /L O	Baseband (I or Q)	80 MHz, nominal (Option 656 and 657)		
Bandwidth (I, Q)	RF (I+Q)	160 MHz, nominal (Option 656 and 657)		

I/Q adjustments represent user interface nominal parameter ranges and not specifications Internal I/Q adjustments apply to RF out and I/Q outputs simultaneously

Amplitude flatness	± 0.2 dB measured with channel corrections optimized for I/Q output
Phase flatness	± 2.5 degrees measured with channel corrections optimized for I/Q output
Common mode I/Q offset	\pm 1.5 V into 50 Ω (200 μ V resolution)
Differential mode I or Q offset	\pm 50 mV into 50 Ω (200 μV resolution)





Internal real-time complex digital I/Q filters (included with Option 656)			
Factory channel correction (256 taps)			
Corrects the linear phase and amplitude responsarrays. (default mode is off)	nse of the baseband I/Q and RF outputs of the signal generator using factory calibration		
RF amplitude flatness (160 MHz)	± 0.2 dB measured		
RF phase flatness (160 MHz)	ERF phase flatness (160 MHz) ± 2 degrees measured		
User channel correction (256 taps)			
Automated routine uses power sensor to corredetails.	ect for linear phase and amplitude response of DUT (equalizer). See Users Guide for more		
Recommended max amplitude error for correction	± 15 dB		
Recommended max phase error for correction ± 25 degrees			
Equalization filter (256 taps)			
User can download and apply inverse or custom phase and amplitude response coefficients from tools such as MATLAB, 89600 VSA or SystemVue to correct for linear errors of DUT/system. See Users Guide for more details.			

	Baseband generator (Options 656 and 657)		
Channels	2 [I and Q]		
Resolution	16 bits [1/65,536]		
O-walls and	Option 656	100 Sa/s to 100 MSa/s	
Sample rate	Option 656 and 657	100 Sa/s to 200 MSa/s	
Maximum number of waveform files in cache	1024		
RF (I+Q) bandwidth	Option 656 Option 656 and 657	80 MHz, nominal 160 MHz, nominal	
Interpolated DAC rate	800 MHz (waveforms only need OSR = 1.25)		
Frequency offset range	± 80 MHz		
Digital sweep modes	In list sweep mode each point in the list can ha with user definable frequencies and amplitudes Specifications sections for more detail.		
	SCPI mode	≤ 5 ms, measured (standard)	
Wayofawa ayiitabiga agaad 1		≤ 1.2 ms, measured (Option UNZ)	
Waveform switching speed ¹	List/step sweep mode	≤ 5 ms, measured (standard)	
		≤ 900 µs, measured (Option UNZ)	
	FTP LAN to internal SSD	10.7 MB/sec or 2.67 Msa/sec	
	Internal SSD to FTP LAN	7.7 MB/sec 1.92 Msa/sec	
	FTP LAN to BBG	8.2 MB/sec or 2.05 Msa/sec	
	FTP LAN to BBG encrypted	4 MB/sec or 1 Msa/sec	
Waveform transfer rates	USB to BBG	19 MB/sec or 4.75 Msa/sec	
(measured, no markers, unencrypted)	BBG to USB	1.2 MB/sec or 300 Ksa/sec	
	Internal SSD to BBG	48 MB/sec or 12 Msa/sec	
	BBG to internal SSD	1.2 MB/sec or 300 Ksa/sec	
	SD card to BBG (Option 006)	2.7 MB/sec or 678 Ksa/sec	
	BBG to SD card (Option 006)	845 KB/sec or 211 Ksa/sec	

SCPI mode switching speed applies when waveforms are pre-loaded in list sweep and sample rate ≥ 10 MSa/s.

			32 Msa (standard)	
	Maximum playback ca	apacity	512 Msa (Option 022)	
Arbitrary waveform memory			1024 Msa (Option 023)	
Arbitrary waveform memory			3 GBytes/800 Msa (standard)	
	Maximum storage cap	pacity including markers	30 GBytes/7.5 Gsa (Option 009)	
			8 GBytes / 2 Gsa (Option 006)	
			60 samples to 32 Msa (standard)	
	Segment length		60 samples to 512 Msa (Option 022)	
			60 samples to 1024 Msa (Option 023)	
Waveform segments	Minimum memory al-	location per segment	256 samples	
	Maximum number of s	segments	8192	
	Label		Maximum number of waveform files	
	Value		1024	
	Maximum number of s	sequences	2000 depending on non-volatile memory usage	
Waveform sequences	Maximum number of	oogmonto/ooguanoo	32,000 (standard)	
wavelerin sequences	Maximum number of s	segments/sequence	4 million (Option 022 or 023)	
	Maximum number of r	repetitions	65,535	
	Types		Continuous, single, gated, segment advance	
	Source		Trigger key, external, bus (GPIB, LAN, USB)	
		Continuous	Free run, trigger and run, reset and run	
		Single	No retrigger, buffered trigger, restart on trigger	
Triggers	Modes	Gated	Negative polarity or positive polarity	
		Segment advance	Single or continuous	
	External coarse delay	time	5 ns to 40 s	
	External coarse delay	resolution	5 ns	
	Trigger latency (Single	e trigger only)	356 ns + 1 sample clock period, nominal	

	Trigger accuracy (Single trigger only)	± 2.5 ns, nominal	
	Single trigger - restart on trigger mode will initiat re-filling the buffer. The latency is 8 µs + (1406 s nominal		
	Fan out	1 primary and up to 15 secondary	
	Trigger repeatability	< 1 ns, nominal	
	Trigger accuracy	Same as normal mode	
Multi-baseband generator synchronization mode (multiple sources)	Trigger latency	Same as normal mode	
	Fine trigger delay range	See Internal I/Q Baseband section	
	Fine trigger delay resolution	See Internal I/Q Baseband section	
	I/Q phase adjustment range	See Internal I/Q Baseband section	
	Markers are defined in a segment during the wa panel; a marker can also be routed to the RF bla amplitude; see Users Guide for more information	anking, ALC hold functions, and alternate	
	Marker polarity	Negative, positive	
Markers	Number of markers	4	
	RF blanking/burst on/off ratio	80 dB	
	Alternate amplitude control switching speed	See amplitude section	
Real-time modulation FIR filter:	Filter types: Nyquist, root-Nyquist, WCDMA, EDIS-95, User FIR (Applies real-time FIR filtering when playing way size for long simulation times. Option 660 not real-times.	reforms with OSR=1. Helps reduce waveform	
	Real-time baseband generator (Option 660)		
	Cellular real-time applications	LTE-FDD, LTE-TDD, HSPA+/W-CDMA, GSM/EDGE, cdma2000®	
	Real-time navigation	GPS, GLONASS, Galileo	
	Real-time video applications	DVB-T/T2/H/S/S2/C/J.83 Annex A/C, ISDB-T/	
Real-time baseband generator required for real-time Signal Studio applications ¹	Note: Option 660 is not required for real-time c	ustom modulation (Option N5180431B)	
	Memory: Shares memory with Options 656 and	1 657	
	Triggering: Same as Options 656 and 657		
	Markers: 3 markers available, all other features	are same as Options 656 and 657	
. See www.keysight.com/find/signalstu	die for more information		

See www.keysight.com/find/signalstudio for more information.

Digital baseband inputs/outputs (Option 003/004)

Options 003 and 004 activate the rear panel digital I/Q bus and enable connectivity to the N5102A digital signal interface module. In output mode (003), you can deliver realistic complex-modulated signals such as LTE, GPS, WLAN, custom pulses and many others directly to your digital devices and subsystems. In the input mode (004), the interface module ports your digital input to the signal generator's baseband system, providing a quick and easy way of upconverting to calibrated analog I/Q, IF, or RF frequencies. In both operating modes, the interface module adapts to your device with the logic type, data format, clock features, and signaling you require.

Data (requires N5102A)				
Digital data format	User-selectable: 2's complement or binary offset, I/Q (I, I-bar, Q, Q-bar) or digital IF output (real, imaginary)			
Data port	Dual 16-bit data buses support parallel, parallel I/Q interleaved, parallel Q/I interleaved, or serial port configuration			
N5102A connectors (breakout boards)	144-pin Tyco Z-Dok+ connects to break-out boards (included with N5102A) that interface with the following connector types: 68-pin SCSI, 38-pin dual AMP Mictor, 100-pin dual Samtec, 20-pin dual 0.1 inch headers, 40-pin dual 0.1 inch headers			
Lorishman	Single-ended: LVTTL, 1.5V CMOS, 1.8V CMOS, 2.5V CMOS, 3.3.V CMOS			
Logic types	Differential: LVDS			
Data output resampling MXG baseband output is resampled to the arbitrary clock rate set by the user via curve-fit calculations.				
	Clock (requires N5102A)			
Clock input	User selectable: internal clock, device under test clock, or external clock (via SMA or breakout board)			
Olook input	N5102A SMA Ext Clock In connector: 50 Ω , 0 dBm nominal, 1 to 400 MHz			
	User selectable: via breakout board or SMA Clock Out connector			
Clock output	N5102A SMA Clock Out connector: 2 Vpp into load > 5K Ω from 1 to 100 kHz, 400 mVpp into 50 Ω load from 100 kHz to 400 MHz			
Sample rate (limited by MXG sample rate)	User-selectable in parallel mode up to a maximum 200 MHz, but limited by other user settings (see N5102A users guide for more details).			
	User-selectable in serial mode, the maximum rate is 400 MHz/word size.			
Dit rate /limited by MVC comple rate)	Parallel Up to 200 MHz x word size (1.6 Gbps LVDS, CMOS and LVTTL) per parallel bus, 2 parallel buses available			
Bit rate (limited by MXG sample rate)	Serial Up to 400 MHz per serial line (400 Mbps LVDS) or 150 MHz per serial line (150 Mbps (CMOS/LVTTL) 32 lines available)			
Clocks per sample	In parallel output mode, the data sample can be held for 1, 2 or 4 clock cycles			
Clock to data skew	Coarse adjustment in 90° steps from 0 to 270°; fine-adjustment in increments of 100 ps up to 5 ns			
Clock polarity	Clock signals may be inverted			
Frequency reference input	1 to 100 MHz BNC, 50 Ω , 3 dBm ± 6 dB			
Power supply (included on N5102A)	Output: 5V, 4A DC			

	AWGN (Option N5180403B)		
Туре	Real-time, continuously calculated, and played	using DSP	
Modes of operation	Standalone or digitally added to signal played generator	by arbitrary waveform or real-time baseband	
Bandwidth	With Option 656	1 Hz to 80 MHz	
Danuwidin	With Option 656 and 657	1 Hz to 160 MHz	
Crest factor	15 dB		
Randomness	90 bit pseudo-random generation, repetition pe	eriod 313 x 10 ⁹ years	
Carrier-to-noise ratio	± 100 dB when added to signal		
Carrier-to-noise ratio formats	C/N, Eb/No		
Carrier-to-noise ratio error	Magnitude error ≤ 0.2 dB at baseband I/Q outp	outs	
Cu	stom modulation Arb Mode (Option N518043	1B)	
	PSK	BPSK, QPSK, OQPSK, π/4DQPSK, gray coded and unbalanced QPSK, 8PSK, 16PSK, D8PSK, IS95 QPSK, IS95 OQPSK, EDGE, HDQPSK	
	QAM	4, 16, 32, 64, 128, 256, 1024 (and 89600 VSA mappings)	
Modulation	FSK	Selectable: 2, 4, 8, 16, C4FM, HCPM	
IVIOULIALION	MSK	0 to 100°	
	ASK	0 to 100%	
	DVB-S2 APSK	16APSK 2/3, 16APSK 3/4 16APSK 4/5, 16APSK 5/6, 16APSK 8/9, 16APSK 9/10, 32APSK 3/4 32APSK 4/5, 32APSK 5/6, 32APSK 8/9, 32APSK 9/10	
	Number of carriers	Up to 100 (limited by a max bandwidth of 160 MHz depending on symbol rate and modulation type)	
Multicarrier	Frequency offset (per carrier)	Up to -80 to +80 MHz	
	Power offset (per carrier)	0 dB to -40 dB	
Symbol rate	50 sps to 100 Msps		
Filter types	Nyquist, root-Nyquist, Gaussian, rectangular, APCO 25 C4FM, user	IS-95 W/EQ, IS-95 Mod, IS-95 Mod w/EQ, HDQPSK, APCO25 HCPM, SOQPSK-TG	
Quick setup modes	PCO25w/C4FM, APCO25w/CQPSK, Bluetooth®, CDPD, DECT, EDGE, GSM, NADC, PDC, PHS, PWT, TETRA	16APSK 2/3, 16APSK 3/4 16APSK 4/5, 16APSK 5/6, 16APSK 8/9, 16APSK 9/10, 32APSK 3/4, 32APSK 4/5,32APSK 5/6, 32APSK 8/9, 32APSK 9/10	

Custom modulati	on real-time mode (Optio	n N5180431B) (Does	ot require Opti	on 660)		
	PSK	PSK				
	QAM			4, 16, 32, 64, 128, 256, 1024 (and 89600 VSA mappings)		
		Selectable		2,4,8,16 level symmetric, C4FM		
Modulation	FSK	User-defined		Custom map of up to 16 deviation levels		
		Max deviatio	ı	20 MHz		
	MSK	0 to 100°				
	ASK	0 to 100%				
	Custom I/Q	Custom map	of 1024 unique	values		
Frequency offset	Up to -80 MHz to +80	MHz				
Symbol rate	Internal generated dat	a	1 sps up to 100 Msps and max of 10 bits per symbol (Option 656 + 657)			
Symbolitate	External serial data		1 sps to [(50 I	Mbits/sec)/(#bits/symbol)]		
Filter types	Selectable		Nyquist, root-Nyquist, Gaussian, rectangular, APCO 25 (phase 1 and 2 UL and DL), IS-95, WCDMA, EDGE (wide and HSR)			
	Custom FIR		automatically (max) 32 to 64 symb MHz 16 to 32 symb Internal filters	on, up to 64 symbols long, resampled to 1024 coefficients ool filter: symbol rate ≤ 12.5 ool filter: symbol rate ≤ 25 MHz switch to 16 tap when symbol en 25 and 100 MHz		
Quick setup modes				Bluetooth, CDPD, DECT, ICO, CT2, TFTS, SOQPSK		
Trimen dalau	Range		0 to 1,048,575 bits			
Trigger delay	Resolution		1 bit			
	Internally generated	Pseudo-random patterns	PN9, PN11, F	PN15, PN20, PN23		
Data types	and and a gorior according	Repeating sequence	Any 4-bit sequ	uence		
Jam spoo	Direct-pattern RAM [P		32 Mb (standa	ard)		
	Note: Used for custom framing	TDMA/non-standard	512 Mb (Option	512 Mb (Option 022)		

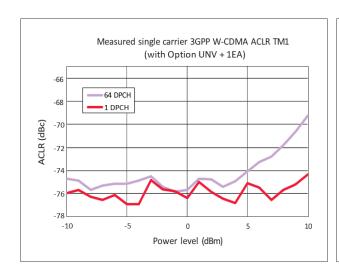
	1		
			1024 Mb (Option 023)
			32 MB (standard)
			512 MB (Option 022)
			1024 MB (Option 023)
	Externally streamed	Туре	Serial data
	data (via AUX I/O)	Inputs/outputs	Data, symbol sync, bit clock
Internal bornt about (coning with hit rate)	Rise/fall time range		Up to 30 bits
Internal burst shape (varies with bit rate)	Rise/fall delay range		-15 to +15 bits
	Multitone and two-tor	ne (Option N5180430B)	
Number of tones	2 to 512, with selectab	le on/off state per tone	
Frequency spacing	100 Hz to 160 MHz (C	ption 656 and 657)	
Phase (per tone)	100 Hz to 160 MHz (C	ption 656 and 657)	
Phase (per tone)	Fixed or random	ption 656 and 657)	432B)
Phase (per tone)	Fixed or random	, ,	432B)
Phase (per tone)	Fixed or random	, ,	432B)
Phase (per tone) Real- Close-in phase noise characteristics Far-out phase noise characteristics	Fixed or random time phase noise impa –20 dB per decade	, ,	432B) Offset settable from 0 to 77 MHz
Phase (per tone) Real- Close-in phase noise characteristics	Fixed or random time phase noise impa -20 dB per decade -20 dB per decade	, ,	

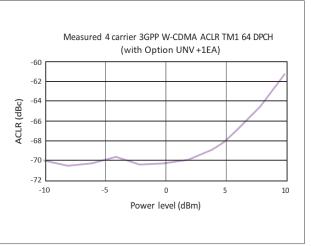


3GPP W-CDMA distortion performance 1,2								
			Standard		Option UNV			UNV with on 1EA
Power level		≤ 2 dBm ²		≤ 2 dBm ²		≤ 5 dBm ²		
Offset	Configuration	Frequency	Spec	Тур	Spec	Тур	Spec	Тур
Adjacent (5 MHz)	1 DDCH 1 corrier	1800 to 2200 MHz	- 69 dBc	-73 dBc	-71 dBc	-75 dBc	-71 dBc	-75 dBc
Alternate (10 MHz)	1 DPCH, 1 carrier		-70 dBc	-75 dBc	-72 dBc	-77 dBc	-71 dBc	-77 dBc
Adjacent (5 MHz)	Test model 1 with	1900 to 2200 MLI-	-68 dBc	-70 dBc	-71 dBc	-73 dBc	-71 dBc	-72 dBc
Alternate (10 MHz)	64 DPCH, 1 carrier	1800 to 2200 MHz		-73 dBc	-72 dBc	-76 dBc	-71 dBc	-76 dBc
Adjacent (5 MHz)	Test model 1 with	1800 to 2200 MHz	-63 dBc	-65 dBc	-65 dBc	-67 dBc	-64 dBc	-66 dBc
Alternate (10 MHz)	64 DPCH, 4 carrier		-64 dBc	-66 dBc	-66 dBc	-68 dBc	-66 dBc	-68 dBc

ACPR specifications apply when the instrument is maintained within 20 to 30 °C.

This is rms power. Convert from rms to peak envelope power (PEP) with the following equation: PEP = rms power + crest factor (for example, 3GPP test model 1 with 64 DPCH has a crest factor 11.5 dB, therefore at +5 dBm rms, the PEP = 5 dBm + 11.5dB = +16.5 dBm PEP).





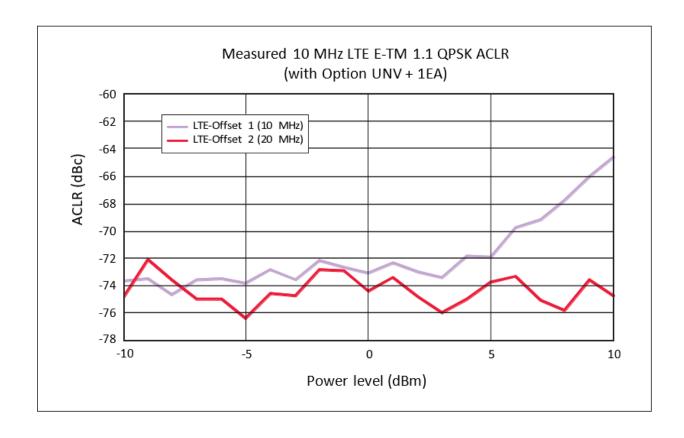
3GPP LTE-FDD distortion performance ¹								
				ndard	Option UNV		Option UNV with Option 1EA	
Power level			≤ 2 dBm ²		≤ 2 dBm ²		≤ 5 dBm ²	
Offset	Configuration	Frequency	Spec	Тур	Spec	Тур	Spec	Тур
Adjacent (10 MHz) ³	10 MHz E-TM 1.1 QPSK	1800 to 2200 MHz	-64 dBc	-66 dBc	-67 dBc	-69 dBc	-64 dBc	-67 dBc
Alternate (20 MHz) ³			-66 dBc	-68 dBc	-69 dBc	-71 dBc	-69 dBc	-71 dBc

ACPR specifications apply when the instrument is maintained within 20 to 30 °C.

This is rms power. Convert from rms to peak envelope power with the following equation: PEP = rms power + crest factor (for example, 3GPP test model 1 with 64 DPCH has a crest factor 11.5 dB, therefore at +5 dBm rms, the PEP = 5 dBm + 11.5 dB = +16.5 dBm PEP).

ACPR measurement configuration: reference channel integration BW: 9.015 MHz, offset channel integration beautifults: 9.015 MHz.

bandwidth: 9.015 MHz.



GSM/EDGE output RF spectrum (ORFS)						
			G	SM	ED	GE
Power level			< +7 dBm		<+7 dBm	
Offset	Configuration	Frequency 1	Standard, typical	Option UNV, typical	Standard, typical	Option UNV, typical
200 kHz			-34 dBc	-36 dBc	-37 dBc	-38 dBc
400 kHz	_		-69 dBc	-70 dBc	-69 dBc	-70 dBc
600 kHz	1 normal timeslot, bursted	800 to 900 MHz 1800 to 1900	-81 dBc	-82 dBc	-80 dBc	-81 dBc
800 kHz	-	MHz	-82 dBc	-83 dBc	-82 dBc	-83 dBc
1200 kHz	_		-84 dBc	-85 dBc	-83 dBc	-84 dBc
		3GPP2 cdma20	000 distortion perfo	rmance, typical		
			Standard	Option UNV	Option UNV + 1EA	
Power level ²			≤ 2dBm	≤2 dBm	≤ 5 dBm	
Offset	Configuration	Frequency (1)	Typical	Typical	Typical	
885 kHz to 1.98 MHz			-78 dBc	-79 dBc	-77 dBc	
1.98 to 4.0 MHz	9 channel forward link	800 to 900 MHz	-86 dBc	-87 dBc	-87 dBc	
> 4.0 to 10 MHz	_		-91dBc	-93 dBc	-93 dBc	
	8	802.16e Mobile WiM	AX™ distortion per	formance, measure	d	
Power	Offset ³	Configuration ⁴	Frequency	Standard, measured	UNV, measured	
< -7 dBm	10 MHz	QPSK	2.5 and 3.5 GHz	-65 dBc	-68 dBc	
Up to +5 dBm	10 MHz	QPSK	3.5 GHz	-62 dBc	-65 dBc	

^{1.} Performance evaluated at bottom, middle, and top of bands shown.

^{2.} This is rms power. Convert from rms to peak envelope power (PEP) with the following equation: PEP = rms power + crest factor (for example: 3GPP test model 1 with 64 DPCH has a crest factor > 11 dB, therefore at +5 dBm rms the PEP = 5 dBm + 11 dB = +16 dBm PEP).

^{3.} Measurement configuration: reference channel integration BW: 9.5 MHz, offset channel integration BW: 9 MHz, channel offset: 10 MHz.

^{4. 802.16}e WiMAX signal configuration-bandwidth: 10 MHz, FFT: 1024, frame length: 5 ms, guard period: 1/ 8, symbol rolloff: 5%, content: 30 symbols of PN9 data.

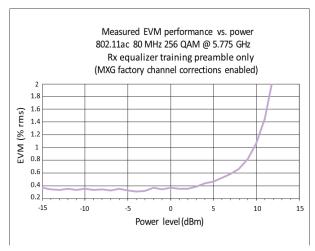
EVM performance data ^{1, 2}										
Format	GSM		EDGE		cdma2000/IS95A		W-CDMA	W-CDMA		
Modulation type	GMSK (bur	sted)	3pi/8 8PS	K (bursted)	QPSK		QPSK		64 QAM	
Modulation rate	270.833 ks	ps	70.833 ks	ps	1.2288 Mc	:ps	3.84 Mcps		10 MHz BV	I
Configuration	1 timeslot		1 timeslot		Pilot chan	nel	1 DPCH		E-TM 3.1	
Frequency ⁴	800 to 900 1800 to 190		800 to 900 1800 to 19		800 to 900 1800 to 19		1800 to 22	00 MHz	1800 to 220	00 MHz
EVM power level	≤7 dBm		≤ 7 dBm		≤7 dBm		≤7 dBm		≤ 7 dBm	
EVM power level with Option 1EA	≤ 13 dBm		≤ 13 dBm		≤ 13 dBm		≤ 13 dBm		≤ 13 dBm	
EVM/global phase	Spec	Тур	Spec	Тур	Spec	Тур	Spec	Тур	Measured	
error	rms 0.8 °	0.2 °	1.2%	0.75%	1.3%	0.8%	1.2%	0.8%	0.2%	
Format	802.11a/g	802.11ac ⁵	QPSK				16 QAM			
Modulation type	64 QAM	256 QAM	QPSK				16 QAM			
Modulation rate	54 Mbps	80 MHz	4 Msps (re	oot-Nyquist t	filter α = 0.2	5)				
F=======4	2400 to 2484 MHz	5.775 GHz	< 2 CLI-							
Frequency ⁴	5150 to 5825 MHz		≤ 3 GHz		≤6 GHz		≤ 3 GHz		≤ 6 GHz	
EVM power level	≤ –5 dBm	≤ -5 dBm	≤ 4 dBm		≤ 4 dBm		≤ 4 dBm		≤ 4 dBm	
EVM power level with Option 1EA	≤ 2 dBm	≤ 2 dBm	≤ 10 dBm		≤ 10 dBm		≤ 10 dBm		≤ 10 dBm	
EVM	Measured	Measured	Spec	Тур	Spec	Тур	Spec	Тур	Spec	Тур
⊏ V IVI	0.3%	0.4%	1.2%	0.8%	1.9%	1.1%	1.1%	0.65%	1.5%	0.9%

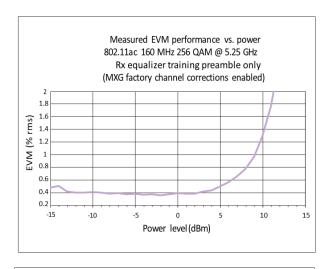
EVM specifications apply for the default ARB file setup conditions with the default ARB files supplied with the instrument. EVM specifications apply after execution of I/Q calibration when the instrument is maintained within ± 5 °C of the

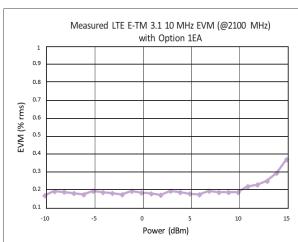
LTE FDD E-TM 3.1, 10 MHz, 64 QAM PDSCH, full resource block. Measured EVM after DC calibration.

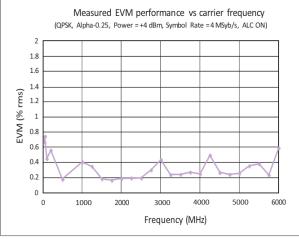
Performance evaluated at bottom, middle, and top of bands shown.

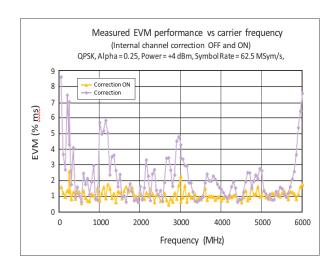
WLAN 802.11ac 80 MHz, 256 QAM, MCS 8, 7 symbols, no filtering. Channel corrections enabled. Rx equalizer training preamble only.

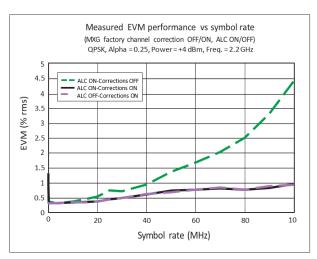












	Bit error rate [BER] analyzer (Option UN7)
Clock rate	100 Hz to 60 MHz (usable to 90 MHz)
Data patterns	PN9, 11, 15, 20, 23
Resolution	10 digits
Bit sequence length	100 bits to 4,294 Gbits after synchronization
Other features	Input clock phase adjustment and gate delay Direct measurement triggering Data and reference signal outputs Real-time display Bit count Error-bit-count Bit error rate Pass/fail indication Valid data and clock detection Automatic re-synchronization Special pattern ignore

General Specifications

Remote programming				
Interfaces	GPIB IEEE-488.2, 1987 with listen and talk LAN 1000BaseT LAN interface, LXI class C compliant USB Version 2.0			
Control languages	Control languages SCPI Version 1997.0			
Compatibility languages	Keysight Technologies: N5181A\61A, N 5182A\62A, N5183A, E4438C, E4428C, E442xB, E443xB, E8241A, E8244A, E8251A, E8254A, E8247C, E8257C/D, E8267C/D, 8648 Series, 8656B, E8663B, 8657A/B, 8662A, 8663A Aeroflex Incorporated: 3410 Series Rohde & Schwarz: SMB100A, SMBV100A, SMU200A, SMJ100A, SMATE200A, SMIQ, SMI			
	Power requirements			
100/120 VAC, 50/60/400 Hz 220/240 VAC, 50/60 Hz 160 W maximum (N5181B) 300 W maximum (N5182B)				
	Operating temperature range			
0 to 55 °C				
Storage temperature range				
-40 to 70 °C				
Operating and storage altitude				
Up to 4,600 meters Up to 3,000 meters (Option 660 only)				
Indoor use				
For indoor use only				
Humidity				
Maximum Relative Humidity (non-condensing): 95%RH up to 40°C, decreases linearly to 45%RH at 55°C.				
	Environmental stress			
the environmental stresses of storage, transpo	d in accordance with the Keysight Environmental Test Manual and verified to be robust against protation and end-use; those stresses include but are not limited to temperature, humidity, it is not that methods are aligned with IEC 60068.2 and levels are similar to MIL PRE 288005.			

^{1.} From 40 °C to 55 °C, the maximum % Relative Humidity follows the line of constant dew point.

shock, vibration, altitude, and power line conditions; test methods are aligned with IEC 60068-2 and levels are similar to MIL-PRF-28800F

Safety

Complies with European Low Voltage Directive 2006/95/EC

– IEC/EN 61010-1, 2nd Edition– Canada: CSA C22.2 No. 61010-1

– USA: UL std no. 61010-1, 2nd Edition

- German Acoustic statement

Acoustic noise emission

LpA < 70 dB Operator position Normal position Per ISO 7779 Geraeuschemission LpA < 70 dB Am Arbeitsplatz

Normaler Betrieb
Nach DIN 45635 t.19

Complies with European EMC Directive 2004/108/EC

IEC/EN 61326-1or IEC/EN 61326-2-1
 CISPR Pub 11 Group 1, class A
 AS/NZS CISPR 11
 ICES/NMB-001

This ISM device complies with Canadian ICES-001; cet appareil ISM est conforme a la norme NMB-001 du Canada

Memory

- Memory is shared by instrument states, user data files, sweep list files, waveform sequences, and other files

3 GB (30 GB with Option 009) memory available in the N5182B

Security Option 006 allows storage of up to 8 GB on SD card

Depending on how the memory is utilized, a maximum of 1000 instrument states can be saved

Security (Option 006)

No internal non-volatile memory (Option SD0)

Disable/remove any internal non-volatile memory or solid state drive

User will not be able to store any files in the internal memory of the instrument

Not compatible with instrument hardware option 009 (Internal Solid State Memory) and option 660 (Base Band Generator with Real-Time Capability)

Requires firmware B.01.80 or newer

Self-test

Internal diagnostic routines test most modules in a preset condition; for each module, if its node voltages are within acceptable limits, the module passes the test.

Weight

N5181B: \leq 13.6 kg (30 lb) net, \leq 28.6 kg (63 lb) shipping N5182B: \leq 15.9 kg (35 lb) net, \leq 30.8 kg (68 lb) shipping

Dimensions

88 mm Hx 426 mm W x 489 mm L (length includes rear panel feet)

(3.5 in H x 16.8 in W x 19.2 in L)

Max length (L) include RF connector tip to end of rear panel feet is 508 mm (20 in)

Recommended calibration cycle

36 months

ISO compliant

This instrument is manufactured in an ISO-9001 registered facility in concurrence with Keysight Technologies' commitment to quality.

Inputs and Outputs

Front panel connectors			
RF output	Outputs the RF signal via a precision N type female connector; see output section for reverse power protection information		
I and Q inputs	BNC input accepts "in-phase" and "quadrature" input signals for I/Q modulation; nominal input imped- ance is 50 Ω , damage levels are 1 Vrms and 5 Vpeak		
USB 2.0	Used with a memory stick for transferring instrument states, licenses and other files into or out of the instrument; also used with U2000, U848X and U202X Series USB power sensors.		
Rear panel connectors			
Rear panel inputs and outputs are 3.3 V C voltage levels	MOS, unless indicated otherwise; CMOS inputs will accept 5 V CMOS, 3 V CMOS, or TTL		
RF output (Option 1EM)	Outputs the RF signal via a precision N type female connector		
I and Q inputs (Option 1EM)	Accepts "in-phase" and "quadrature" input signals for I/Q modulation SMB connector, nominal input impedance is 50 Ω ; damage levels are 1 Vrms and 5 Vpeak; Option 1EM units will come with 2 SMB to BNC adapters		
I and Q outputs	BNC outputs the analog I/Q modulation signals from the internal baseband generator; nominal output impedance 50 $\Omega,$ DC coupled; damage levels \pm 2 V		
I bar and Q bar outputs (Option 1EL)	BNC outputs the complement of the I and Q signals for differential applications		
Event 1	This connector outputs the programmable timing signal generated by marker 1 The marker signal can also be routed internally to control the RF blanking and ALC hold functions; this signal is also available on the AUX I/O connector With bit error rate analyzer (Option UN7) this connector is used for data input Damage levels are > +8 V and < -4 V		
Pattern trigger	Accepts signal to trigger internal pattern generator to start single pattern output, for use with the internal baseband generators Accepts CMOS signal with minimum pulse width of 10 ns Damage levels are > +8 V and < -4 V		
BBTRIG 1	For arbitrary and real-time baseband generators I/O such as Markers or trigger inputs With bit error rate analyzer (Option UN7) this connector is used for clock input		
BBTRIG 2	For arbitrary and real-time baseband generators I/O such as Markers or trigger inputs With bit error rate analyzer (Option UN7) this connector is used for gate input		
Sweep out	Generates output voltage, 0 to +10 V when the signal generator is sweeping; this output can also be programmed to indicate when the source is settled or output pulse video and is TTL and CMOS compatible in this mode; output impedance < 1 Ω , can drive 2 k Ω ; damage levels are \pm 15 V.		
Ext 1	External AM/FM/PM #1 input; nominal input impedance is 50 Ω /600 Ω /1M $\Omega,$ nominal; damage levels are \pm 5 V		
Ext 2	External AM/FM/PM #2 input; nominal input impedance is 50 $\Omega/600~\Omega$ /1M $\Omega,$ nominal; damage levels are \pm 5 V		
LF OUT	0 to 5 V peak into 50 Ω , –5 V to 5 V offset, nominal		

Pulse	External pulse modulation input; this input is TTL and CMOS compatible; low logic levels are 0 V and high logic levels are +1 V; nominal input impedance is 50 Ω ; input damage levels are \leq -0.3 V and \geq +5.3 V.
Trigger in	Accepts TTL and CMOS level signals for triggering point-to-point in sweep mode; damage levels are \leq -0.3 V and \geq +5.3 V.
Trigger out	Outputs a TTL and CMOS compatible level signal for use with sweep mode. The signal is high at start of dwell, or when waiting for point trigger in manual sweep mode, and low when dwell is over or point trigger is received. This output can also be programmed to indicate when the source is settled, pulse synchronization, or pulse video. Nominal output impedance 50 Ω Input damage levels are \leq -0.3 V and \geq +5.3 V
Reference input	Accepts a 10 MHz reference signal used to frequency lock the internal timebase; Option 1ER adds the capability to lock to a frequency from 1 MHz to 50 MHz; nominal input level -3 to +20 dBm, impedance 50 Ω , sine or square waveform.
10 MHz out	Outputs the 10 MHz reference signal used by internal timebase; level nominally +3.9 dBm; nominal output impedance 50 Ω ; input damage level is +16 dBm.
LO in (Option 012)	Accepts a signal from a primary signal generator that is used as the LO for MXG vector in order to configure a phase coherent system; nominal input levels between 0 to +12 dBm; nominal input impedance 50 Ω .
LO out (Option 012)	Outputs a reference signal that can be used in a phase coherent system; nominal output levels between 0 to +12 dBm; nominal output impedance 50 Ω .
DAC Clk In (Option 012)	Reserved for future use.
Digital bus I/O	To be used with PXB or N5102A digital signal interface module.
Aux I/O	Aux I/O port sends and/or receives auxiliary signaling information: For Option UN7 this connector is used to output reference data, clock, error signals, and more. Output markers to an external device from arbitrary waveform or real-time generation application such as: frame markers, pulse-per-second, even-second, and more. Input signals from external DUT to modify characteristics of a signal being generated such as changing output power (power control loop testing), advancing or delaying timing (timing advance loop testing), HARQ ACK/NAK delivery (HARQ process loop testing) or streaming external data, clock and symbol synch for custom modulation. I/O is application specific (CDMA, 3GPP, GNSS, LTE, custom). See User Guide or Signal Studio help for more details. Connector type: 36 pin 3M connector (part number N10236-52B2PC). The mating connector is a 3M 10136-3000 wire mount plug or 3M 10136-8000 IDC plug with a 3M 10336 shell. For Option N5180431B real-time custom modulation the following pin numbers are assigned: Data input = pin 23 Data clock input = pin 25 Burst input = pin 27 Data output = pin 35 Data clock output = pin 6 Symbol sync output = pin 37 Event 1 output = pin 1 Event 2 output = pin 33
USB 2.0	The USB connector provides remote programming functions via SCPI
LAN (1000 BaseT)	The LAN connector provides the same SCPI remote programming functionality as the GPIB connector and is also used to access the internal Web server and FTP server Supports DHCP, sockets SCPI, VXI-11 SCPI, connection monitoring, dynamic hostname services, TCP keep alive

	LXI class C compliant Trigger response time for the immediate LAN trigger is 0.5 ms (minimum), 4 ms (maximum), 2 ms (typical); delayed/ alarm trigger is unknown Trigger output response time is 0.5 ms (minimum), 4 ms (maximum), 2 ms (typical)
GPIB	The GPIB connector provides remote programming functionality via SCPI

Related Literature

Keysight X-Series Signal Generators		
MXG Configuration Guide	5990-9959EN	
EXG Data Sheet	5991-0039EN	
EXG Configuration Guide	5990-9958EN	
X-Series Signal Generator Brochure	5990-9957EN	
Signal Studio Software Brochure	5989-6448EN	
N5182BX07 User Guide	N5182-90001	

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